

L Number	Hits	S arch Text	DB	Time stamp
5	6708	(430/320-329).CCLS.	USPAT; US-P PUB; DERWENT	2003/06/18 15:24
7	2	(((430/320-329).CCLS.) and ((rais d or r li f) near pattern)) and proto\$type	USPAT; US-PGPUB; DERWENT	2003/06/18 15:26
8	18	(((430/320-329).CCLS.) and ((raised or relief) near pattern)) and decorat\$5	USPAT; US-PGPUB; DERWENT	2003/06/18 15:26
6	339	((430/320-329).CCLS.) and ((raised or relief) near pattern)	USPAT; US-PGPUB; DERWENT	2003/06/18 15:59
9	1220	(430/396,397).CCLS.	USPAT; US-PGPUB; DERWENT	2003/06/18 15:59
10	24	((430/396,397).CCLS.) and ((raised or relief) near pattern)	USPAT; US-PGPUB; DERWENT	2003/06/18 16:08
11	523	(430/269).CCLS.	USPAT; US-PGPUB; DERWENT	2003/06/18 16:08
12	11	((430/269).CCLS.) and ((raised or relief) near pattern)	USPAT; US-PGPUB; DERWENT	2003/06/18 16:10
13	3270	(430/270.1).CCLS.	USPAT; US-PGPUB; DERWENT	2003/06/18 16:10
14	142	((430/270.1).CCLS.) and ((raised or relief) near pattern)	USPAT; US-PGPUB; DERWENT	2003/06/18 16:25
15	81	(430/295).CCLS.	USPAT; US-PGPUB; DERWENT	2003/06/18 16:24
16	730	(430/306).CCLS.	USPAT; US-PGPUB; DERWENT	2003/06/18 16:24
17	46	((430/306).CCLS.) and ((raised or relief) near pattern)	USPAT; US-PGPUB; DERWENT	2003/06/18 16:29
18	1631	(resist or photoresist) and ((raised or relief) near pattern)	USPAT; US-PGPUB; DERWENT	2003/06/18 16:30
19	417	((resist or photoresist) and ((raised or relief) near pattern)) and (stereo\$lithograp\$4 or photo\$lithograp\$4)	USPAT; US-PGPUB; DERWENT	2003/06/18 16:31
20	7	(((resist or photoresist) and ((raised or relief) n ar patt rn)) and (st r o\$lithograp\$4 r ph t \$lithograp\$4)) and pr totyp	USPAT; US-PGPUB; DERWENT	2003/06/18 16:32
21	16	(((r sist or ph tor sist) and ((rais d r reli f) near patt rn)) and (st r \$lithograp\$4 r ph to\$lith grap\$4)) and (d c rat\$4)	USPAT; US-P PUB; DERWENT	2003/06/18 16:33

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